

STPS1150-Y

Automotive power Schottky rectifier

Datasheet - production data

Features

- AEC-Q101 qualified
- Negligible switching losses
- Low forward voltage drop for higher efficiency and extended battery life
- Low thermal resistance
- Surface mount miniature package
- Avalanche capability specified
- ECOPACK[®]2 compliant component

Description

These 150 V power Schottky rectifiers are suited for switch mode power supplies on up to 24 V rails and high frequency converters.

Packaged in SMA, this device is intended for use in automotive applications where low drop forward voltage is required to reduce power dissipation.

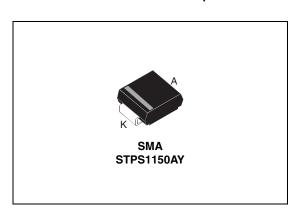


Table 1. Device summary

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Symbol	Values	
I _{F(AV)}	1 A	
V_{RRM}	150 V	
T _j (max)	175 °C	
V _F (max)	0.67 V	

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1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		150	V
I _{F(RMS)}	Forward rms current		15	Α
I _{F(AV)}	Average forward current	$T_L = 150 ^{\circ}\text{C} \delta = 0.5$	1	Α
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	50	Α
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \mu s$ $T_j = 25$ °C		1500	W
T _{stg}	Storage temperature range	-65 to +175	°C	
T _j	Operating junction temperature range ⁽¹⁾		-40 to +175	°C

 $[\]frac{1}{1. \quad \frac{dPtot}{dTj} < \frac{1}{Rth(j-a)} } condition to avoid runaway for a diode on its own heatsink$

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	20	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V - V		0.2	1.0	μΑ
'R`′	neverse leakage current	T _j = 125 °C	$V_R = V_{RRM}$		0.2	1.0	mA
		$T_j = 25 ^{\circ}\text{C}$ $T_j = 125 ^{\circ}\text{C}$ $I_F = 1$	- I _F = 1 A		0.78	0.82	
V _F ⁽²⁾	Forward voltage drop				0.62	0.67	V
VF`'	v _F · · · · · · · · · · · · · · · · · · ·	T _j = 25 °C	I _E = 2 A		0.85	0.89	V
		T _j = 125 °C	1F = 2 A		0.69	0.75	

^{1.} $t_p = 5 \text{ ms}, \ \delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.59 \times I_{F(AV)} + 0.08 I_{F^{2}(RMS)}$$

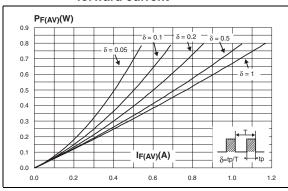
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^{2.} $t_p = 380 \ \mu s, \ \delta < 2\%$

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Figure 1. Average forward power dissipation versus average forward current

Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$)



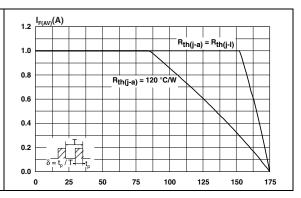
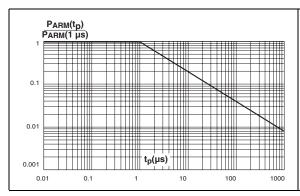


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature



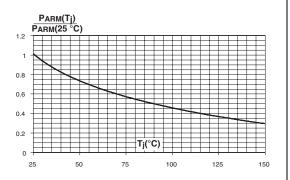
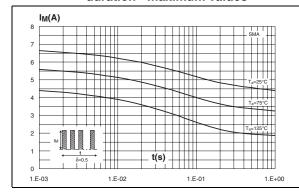
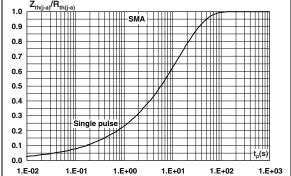


Figure 5. Non repetitive surge peak forward current versus overload duration - maximum values

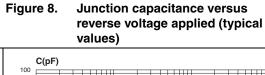
Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration

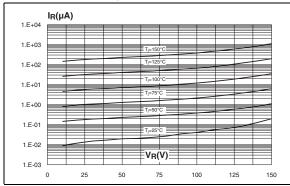




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Figure 7. Reverse leakage current versus reverse voltage applied (typical values)





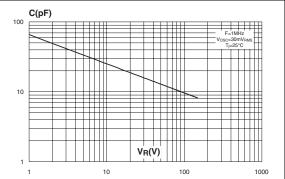
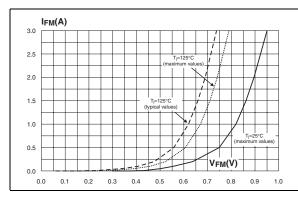
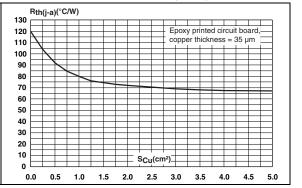


Figure 9. Forward voltage drop versus forward current (all packages)

Figure 10. Thermal resistance junction to ambient versus copper surface under each lead (SMA)





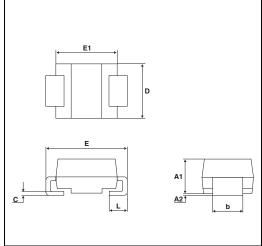
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2 Package information

- Band shows cathode.
- Epoxy meets UL94, V0

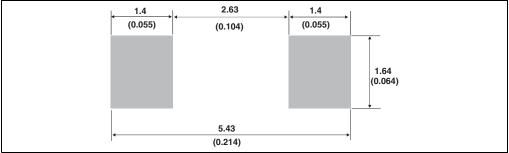
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Table 5. SMA dimensions



	Dimensions				
Ref.	Millimeters		Inc	hes	
	Min.	Max.	Min.	Max.	
A1	1.90	2.45	0.075	0.094	
A2	0.05	0.20	0.002	0.008	
b	1.25	1.65	0.049	0.065	
С	0.15	0.40	0.006	0.016	
D	2.25	2.90	0.089	0.114	
Е	4.80	5.35	0.189	0.211	
E1	3.95	4.60	0.156	0.181	
L	0.75	1.50	0.030	0.059	

Figure 11. Footprint (dimensions in mm)



Ordering information STPS1150-Y

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS1150AY	1150Y	SMA	0.068 g	5000	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
02-Nov-2011	1	Initial release.
02-May-2012	2	Updated Table 3.

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